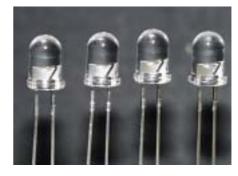


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Technical Data

Ultra Bright LED Lamp for Traffic Sign

LTL2P3SEK	Red	(22°)
LTL2R3SEK	Red	(30°)
LTL2P3SYK	Ambe	r (22º)
LTL2R3SYK	Ambe	r (30°)



Description

The source color light emitting diode dice of these devices is made of AlInGaP on a transparent substrate (TS).

The water clear epoxy lens on these devices create viewing angles of 22 and 30 degrees that match international specifications for traffic sign utilization.

These LED lamps provide superior endurance against moisture and high temperatures thus are reliable for outdoor environment use. With a lower power consumption than traditional incandescent lamps, these devices yield lower system cost.

Benefits

- * Lower system cost.
- * Higher luminous efficiency than incandescent lamp.
- * Fewer LED are required due to the TS AlInGaP technology.

Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on PCB or panel.
- * I.C. Compatible / low current requirements.
- * Popular T-1 $\frac{\frac{3}{4}}{4}$ diameter (5 mm).

Applications

- * Traffic signals.
- * Versatile warning signals.
- * Outdoor traffic display panels.

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK

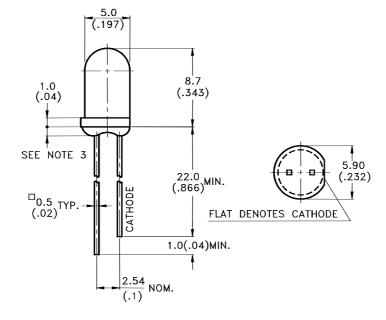


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Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on PCB or panel.
- * I.C. Compatible / low current requirements.
- * Popular T-1 3/4 diameter.

Package Dimensions



Part No.	Lens	Source Color
LTL2P3SEK / LTL2R3SEK	Water Clear	TS AlInGaP Red
LTL2P3SYK / LTL2R3SYK	Water Clear	TS AlInGaP Amber

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm (.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK

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Parameter	Maximum Rating	Unit
Power Dissipation	130	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
DC Forward Current	50	mA
Derating Linear From 50 °C	0.6	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-40° C to $+80^{\circ}$ C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK

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Electrical / Optical Characteristics at TA=25 °C							
Parameter	Symbol	Part NO. (LTL)	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	2P3SEK 2R3SEK 2P3SYK 2R3SYK	2500 1900 1900 1900	4800 3700 3700 2800		mcd	I _F = 20mA Note 1
Viewing Angle	20 _{1/2}	2P3SXK 2R3SXK		22 30		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λp	Red Amber		639 591		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	Red Amber		630 590		nm	Note 4
Spectral Line Half-Width	Δλ	Red Amber		17 17		nm	
Forward Voltage	VF	Red Amber		2.25 2.35	2.7 2.7	v	$I_F = 20 m A$
Reverse Current	Ir				100	μΑ	$V_R = 5V$
Capacitance	C			40		pF	$V_F = 0$, $f = 1MHz$

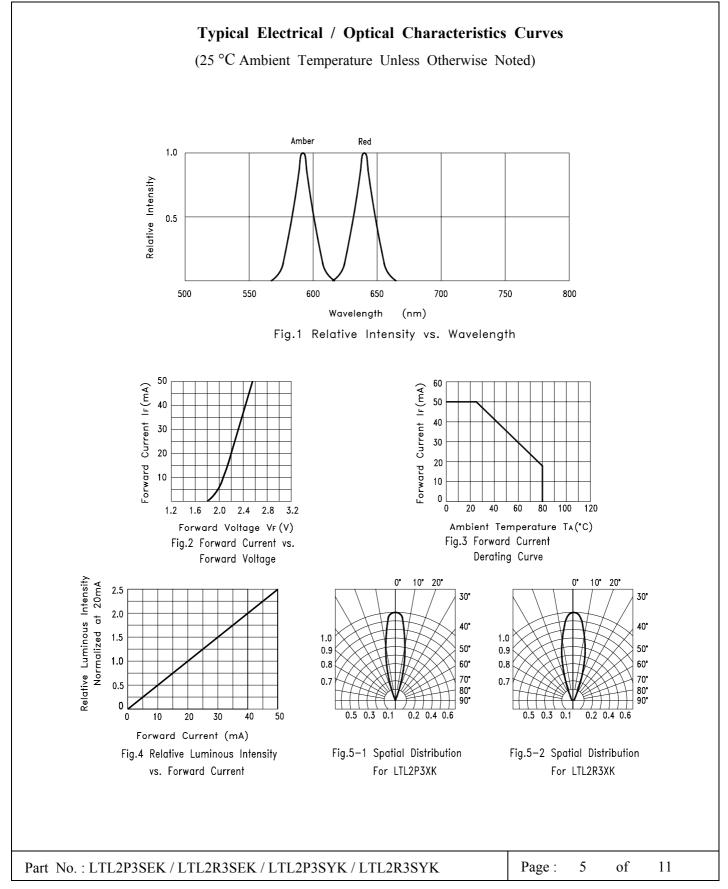
NOTE:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK



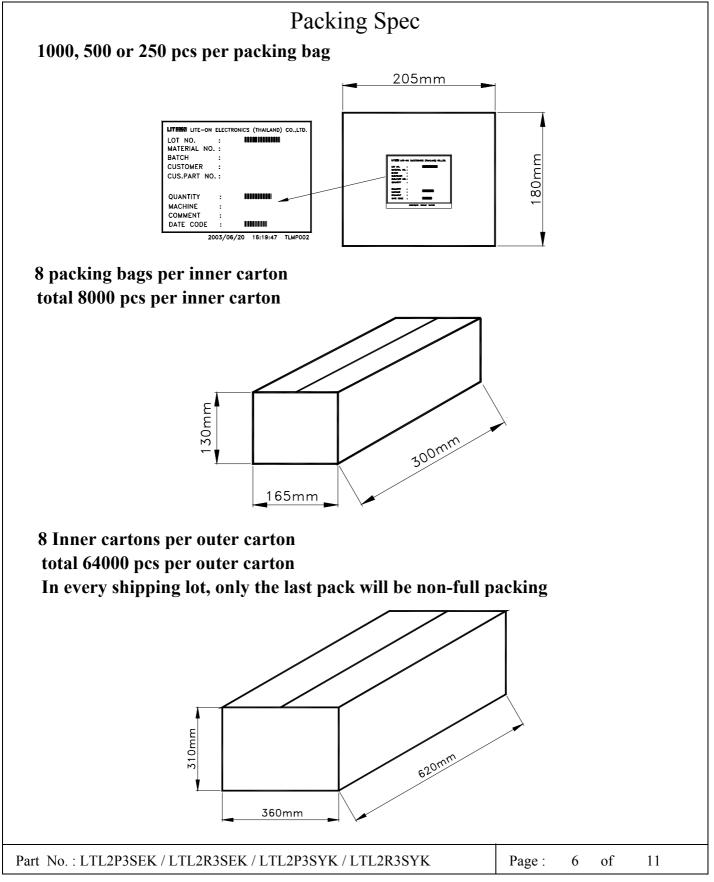
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BNS-OD-C131/A4



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Bin Code List For Reference				
Luminous Intensity Iv(mcd) IF@20mA				
Bin Code	Min.	Max.		
S	1900	2500		
Т	2500	3200		
U	3200	4200		
V	4200	5500		
W	5500	7200		
Х	7200	9300		

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength λd(nm) IF@20mA				
Bin Code	Min.	Max.		
А	584.5	587.0		
В	587.0	589.5		
С	589.5	592.0		
D	592.0	594.5		
Е	594.5	597.0		

Note: Tolerance of each bin limit is ± 1 nm

Forward Voltage Vf (Volts) IF@20mA		
Bin Code	Min.	Max.
1	1.8	1.9
2	1.9	2.0
3	2.0	2.1
4	2.1	2.2
5	2.2	2.3
6	2.3	2.4
7	2.4	2.5
8	2.5	2.6
9	2.6	2.7

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK
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BNS-OD-C131/A4



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CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions :

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

Part No.: LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK

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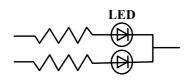


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6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B LED

- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No.: LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK



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Suggested checking list :

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle? Others
 - 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK



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8. Reliability Test Classification **Test Item Test Condition Reference Standard** Ta= Under Room Temperature As MIL-STD-750D:1026 (1995) Operation Life Per Data Sheet Maximum Rating MIL-STD-883D:1005 (1991) *Test Time= 1000HRS (-24HRS,+72HRS) JIS C 7021:B-1 (1982) **High Temperature** MIL-STD-202F: 103B(1980) $Ta = 65 \pm 5^{\circ}C$ RH= $90 \sim 95\%$ High Humidity JIS C 7021 : B-11(1982) Test Time= 240HRS±2HRS Storage $Ta = 65 \pm 5^{\circ}C$ High Temperature Endurance RH= $90 \sim 95\%$ High Humidity JIS C 7021 : B-11(1982) VR=5V Test **Reverse BIAS** Test Time = 500HRS (-24HRS, +48HRS) High Temperature Ta= 105±5°C MIL-STD-883D:1008 (1991) *Test Time= 1000HRS (-24HRS,+72HRS) JIS C 7021:B-10 (1982) Storage Low Temperature $Ta = -55 \pm 5^{\circ}C$ JIS C 7021:B-12 (1982) Storage *Test Time=1000HRS (-24HRS,+72HRS) MIL-STD-202F:107D (1980) $105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ Temperature MIL-STD-750D:1051(1995) 30mins 5mins 30mins 5mins Cycling MIL-STD-883D:1010 (1991) 10 Cycles JIS C 7021: A-4(1982) $105 \pm 5^{\circ}C \sim -55^{\circ}C \pm 5^{\circ}C$ MIL-STD-202F:107D(1980) Thermal 10mins 10mins MIL-STD-750D:1051(1995) Shock 10 Cycles MIL-STD-883D:1011 (1991) Environmental Test MIL-STD-202F:210A(1980) Solder $T.sol = 260 \pm 5^{\circ}C$ MIL-STD-750D:2031(1995) Resistance Dwell Time= 10 ± 1 secs JIS C 7021: A-1(1982) MIL-STD-202F:208D(1980) T. sol = $230 \pm 5^{\circ}$ C MIL-STD-750D:2026(1995) Solderability Dwell Time= 5 ± 1 secs MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No. : LTL2P3SEK / LTL2R3SEK / LTL2P3SYK / LTL2R3SYK

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